

P-Channel JFET Switch



J174 – J177 / SST174 – SST177

FEATURES

- Low Insertion Loss
- No Offset or Error Generated By Closed Switch
 - Purely Resistive
 - High Isolation Resistance From Driver
- Short Sample and Hold Aperture Time
- Fast Switching

APPLICATIONS

- Analog Switches
- Choppers
- Commutators

ABSOLUTE MAXIMUM RATINGS

($T_A = 25^{\circ}\text{C}$ unless otherwise specified)

Gate-Drain or Gate-Source Voltage 30V
Gate Current 50mA
Storage Temperature Range -55°C to $+150^{\circ}\text{C}$
Operating Temperature Range -55°C to $+135^{\circ}\text{C}$
Lead Temperature (Soldering, 10sec) 300°C
Power Dissipation 350mW
Derate above 25°C $3.3\text{mW}/^{\circ}\text{C}$

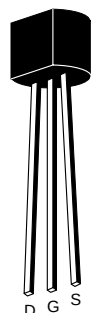
NOTE: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ORDERING INFORMATION

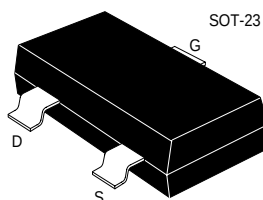
Part	Package	Temperature Range
J174-J177	Plastic TO-92	-55°C to $+135^{\circ}\text{C}$
SST174-SST177	Plastic SOT-23	-55°C to $+135^{\circ}\text{C}$

For Sorted Chips in Carriers see 2N5114 series.

PIN CONFIGURATION



TO-92



SOT-23

5508

PRODUCT MARKING (SOT-23)

SST174	P04
SST175	P05
SST176	P06
SST177	P07



ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}\text{C}$ unless otherwise specified)

SYMBOL	PARAMETER	J174			J175			J176			J177			UNITS	TEST CONDITIONS
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
I _{GSS}	Gate Reverse Current (Note 1)			1			1			1			1	nA	V _{DS} = 0, V _{GS} = 20V
V _{GS(off)}	Gate Source Cutoff Voltage	5		10	3		6	1		4	0.8		2.25	V	V _{DS} = -15V, I _D = -10nA
BV _{GSS}	Gate Source Breakdown Voltage	30			30			30			30				V _{DS} = 0, I _G = 1μA
I _{DSS}	Drain Saturation Current (Note 2)	-20		-135	-7		-70	-2		-35	-1.5		-20	mA	V _{DS} = -15V, V _{GS} = 0
I _{D(off)}	Drain Cutoff Current (Note 1)			-1			-1			-1			-1	nA	V _{DS} = -15V, V _{GS} = 10V
r _{DS(on)}	Drain-Source ON Resistance			85			125			250			300	Ω	V _{GS} = 0, V _{DS} = -0.1V
C _{dg(off)}	Drain-Gate OFF Capacitance		5.5			5.5			5.5			5.5		pF	V _{DS} = 0, V _{GS} = 10V
C _{sg(off)}	Source-Gate OFF Capacitance		5.5			5.5			5.5			5.5			f = 1MHz (Note 3)
C _{dg(on)} + C _{sg(on)}	Drain-Gate Plus Source Gate ON Capacitance		32			32			32			32			V _{DS} = V _{GS} = 0
t _{d(on)}	Turn On Delay Time		2			5			15			20		ns	Switching Time Test Conditions (Note 3)
t _r	Rise Time		5			10			20			25			V _{DD} -10V J174 -10V J175 -6V J176 -6V J177 -6V
t _{d(off)}	Turn Off Delay Time		5			10			15			20			V _{GS(off)} 12V J174 12V J175 8V J176 3V J177 3V
t _f	Fall Time		10			20			20			25			R _L 560Ω J174 12kΩ J175 5.6kΩ J176 10kΩ J177 10kΩ
															V _{GS(on)} 0V J174 0V J175 0V J176 0V J177 0V

- NOTES:** 1. Approximately doubles for every 10°C increase in T_A .
 2. Pulse test duration $\sim 300\mu s$; duty cycle $\leq 3\%$.
 3. For design reference only, not 100% tested.